

# Frequency Timing Generator for Pentium/Pro™ or Transmeta™ Efficeon™

## General Description

**ICS9148-12** is a Clock Synthesizer chip for Pentium/Pro-based Desktop/Notebook systems or Transmeta Efficeon Mobile systems.

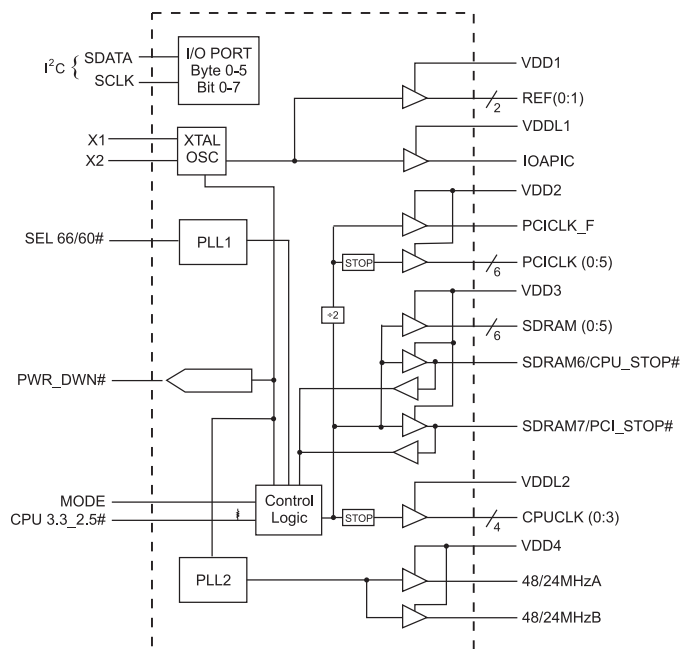
Features include four strong CPU, seven PCI and eight SDRAM clocks. Two reference outputs are available equal to the crystal frequency. Stronger drive CPUCLK outputs typically provide greater than 1 V/ns slew rate into 20pF loads. This device meets rise and fall requirements with 2 loads per CPU output (ie, one clock to CPU and NB chipset, one clock to two L2 cache inputs).

PWR\_DWN# pin allows low power mode by stopping crystal OSC and PLL stages. For optional power management, CPU\_STOP# can stop CPU (0:3) clocks and PCI\_STOP# will stop PCICLK (0:5) clocks. CPU and IOAPIC output buffer strength controlled by CPU 3.3\_2.5# pin to match VDDL voltage.

PCICLK outputs typically provide better than 1V/ns slew rate into 30pF loads while maintaining 50±5% duty cycle. The REF clock outputs typically provide better than 0.5V/ns slew rates.

The **ICS9148-12** accepts a 14.318MHz reference crystal or clock as its input and runs on a 3.3V core supply.

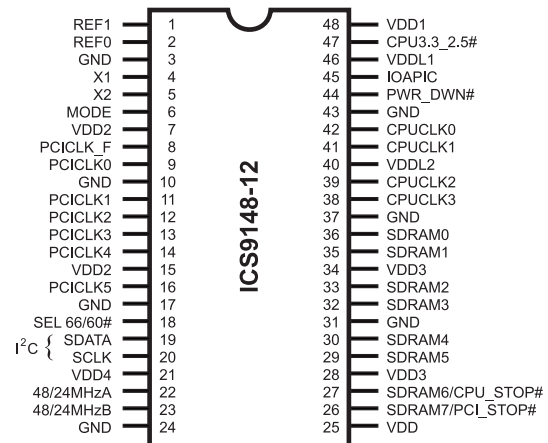
## Block Diagram



## Features

- CPU outputs are stronger drive for multiple loads per pin (ie CPU and NB on one pin)
- Generates system clocks for CPU, IOAPIC, SDRAM, PCI, plus 14.314 MHz REF(0:1), USB, Plus Super I/O
- Supports single or dual processor systems
- I²C serial configuration interface provides output clock disabling and other functions
- MODE input pin selects optional power management input control pins
- Two fixed outputs separately selectable as 24 or 48MHz
- Separate 2.5V and 3.3V supply pins
- 2.5V or 3.3V outputs: CPU, IOAPIC
- 3.3V outputs: SDRAM, PCI, REF, 48/24 MHz
- CPU 3.3\_2.5# logic pin to adjust output strength
- No power supply sequence requirements
- Uses external 14.318MHz crystal
- 48 pin 300 mil SSOP and 240 mil TSSOP
- Output enable register for serial port control:
  - 1 = enable
  - 0 = disable

## Pin Configuration



## 48-Pin SSOP & TSSOP

## Functionality

VDD (1:4) 3.3V±10%, VDDL1, 2 2.5±5% or 3.3±10% 0-70°C  
Crystal (X1, X2) = 14.31818 MHz

| SEL | CPUCLK, SDRAM (MHz) | PCICLK (MHz) |
|-----|---------------------|--------------|
| 0   | 60                  | 30           |
| 1   | 66.6                | 33.3         |

## Pin Descriptions

| PIN NUMBER                   | PIN NAME     | TYPE | DESCRIPTION  |
|------------------------------|--------------|------|--|
| 2, 1                         | REF (0:1)    | OUT  | Reference clock Output   |
| 3, 10, 17, 24,<br>31, 37, 43 | GND          | PWR  | Ground (common)  |
| 4                            | X1           | IN   | Crystal or reference input, has internal crystal load cap                          |
| 5                            | X2           | OUT  | Crystal output, has internal load cap and feedback resistor to X1                  |
| 6                            | MODE         | IN   | Input function selection   |
| 7, 15                        | VDD2         | PWR  | Supply for PCICLK_F, PCICLK (0:5), nominal 3.3V                                    |
| 8                            | PCICLK_F     | OUT  | Free running PCI clock, not affected by PCI_STOP#                                  |
| 9, 11, 12, 13, 14, 16        | PCICLK (0:5) | OUT  | PCI clocks   |
| 18                           | SEL66/60#    | IN   | Selects 60MHz or 66.6MHz for SDRAM and CPU   |
| 19                           | SDATA        | IN   | I <sup>2</sup> C data input  |
| 20                           | SCLK         | IN   | I <sup>2</sup> C clock input   |
| 21                           | VDD4         | PWR  | Supply for 48/24MHzA, 48/24MHzB, nominal 3.3V                                      |
| 22                           | 48/24MHzA    | OUT  | 48/24MHz driver output for USB or Super I/O  |
| 23                           | 48/24MHzB    | OUT  | 48/24MHz driver output for USB or Super I/O  |
| 25                           | VDD          | PWR  | Supply for PLL core, nominal 3.3V  |
| 26                           | SDRAM7       | OUT  | SDRAM clock 60/66.6MHz (selected)  |
|                              | PCI_STOP#    | IN   | Halts PCI Bus (0:5) at logic "0" level when low                                    |
| 27                           | SDRAM6       | OUT  | SDRAM clock 60/66.6MHz (selected)  |
|                              | CPU_STOP#    | IN   | Halts CPU clocks at logic "0" level when low                                       |
| 28, 34                       | VDD3         | PWR  | Supply for SDRAM (0:5), SDRAM6/CPU_STOP#, SDRAM7/PCI_STOP#, nominal 3.3V           |
| 40                           | VDDL2        | PWR  | Supply for CPUCLK (0:3), either 2.5 or 3.3V nominal                                |
| 42, 41, 39, 38               | CPUCLK (0:3) | OUT  | CPUCLK clock output, powered by VDDL2  |
| 36, 35, 33, 32, 30, 29       | SDRAM (0:5)  | OUT  | SDRAMs clock at 60 or 66.6MHz (selected)   |
| 44                           | PWR_DWN#     | IN   | Powers down chip, active low   |
| 45                           | IOAPIC       | OUT  | IOAPIC clock output, (14.318MHz) powered by VDDL1                                  |
| 46                           | VDDL1        | PWR  | Supply for IOAPIC, either 2.5 or 3.3V nominal                                      |
| 47                           | CPU3.3-2.5#  | IN   | 3.3 or 2.5 VDD buffer strength selection, has pullup to VDD, nominal 30K resistor. |
| 48                           | VDD1         | PWR  | Supply for REF (0:1), X1, X2, nominal 3.3V   |

## Power Groups

VDD = Supply for PLL core

VDD1 = REF (0:1), X1, X2

VDD2 = PCICLK\_F, PCICLK (0:5)

VDD3 = SDRAM (0:5), SDRAM6/CPU\_STOP#, SDRAM7/PCI\_STOP#

VDD4 = 48/24MHzA, 48/24MHzB

VDDL1 = IOAPIC

VDDL2 = CPUCLK (0:3)

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## Power-On Conditions

| SEL 66/60# | MODE | PIN #                          | DESCRIPTION | FUNCTION   |
|------------|------|--------------------------------|-------------|--|
| 1          | 1    | 38, 39, 41, 42                 | CPUCLKs     | 66.6 MHz - w/serial config enable/disable  |
|            |      | 36, 35, 33, 32, 30, 29, 27, 26 | SDRAM       | 66.6 MHz - All SDRAM outputs   |
|            |      | 16, 14, 13, 12, 11, 9, 8       | PCICLKs     | 33.3 MHz - w/serial config enable/disable  |
| 0          | 1    | 38, 39, 41, 42                 | CPUCLKs     | 60 MHz - w/serial config enable/disable  |
|            |      | 36, 35, 33, 32, 30, 29, 27, 26 | SDRAM       | 60 MHz - w/serial config enable/disable  |
|            |      | 16, 14, 13, 12, 11, 9, 8       | PCICLKs     | 30 MHz - w/serial config enable/disable  |
| 1          | 0    | 26                             | PCI_STOP#   | Power Management, PCI (0:5) Clocks Stopped when low  |
|            |      | 27                             | CPU_STOP#   | Power Management, CPU (0:5) Clocks Stopped when low  |
|            |      | 8                              | PCICLK_F    | 33.3 MHz - 33.3 MHz - PCI Clock Free running for Power Management                          |
|            |      | 38, 39, 41, 42                 | CPUCLKs     | 66.6 MHz - CPU Clocks w/external Stop Control and serial config individual enable/disable. |
|            |      | 36, 35, 33, 32, 30, 29         | SDRAM       | 66.6 MHz - SDRAM Clocks w/serial config individual enable/disable.                         |
|            |      | 16, 14, 13, 12, 11, 9          | PCICLKs     | 33.3 MHz - PCI Clocks w/external Stop control and serial config individual enable/disable. |
| 0          | 0    | 26                             | PCI_STOP#   | Power Management, PCI (0:5) Clocks Stopped when low  |
|            |      | 27                             | CPU_STOP#   | Power Management, CPU (0:5) Clocks Stopped when low  |
|            |      | 8                              | PCICLK_F    | 30 MHz - PCI Clock Free running for Power Management                                       |
|            |      | 38, 39, 41, 42                 | CPUCLKs     | 60 MHz - CPU Clocks w/external Stop control and serial config individual enable/disable.   |
|            |      | 36, 35, 33, 32, 30, 29         | SDRAM       | 60 MHz - SDRAM Clocks w/serial config individual enable/disable.                           |
|            |      | 16, 14, 13, 12, 11, 9          | PCICLKs     | 30 MHz - PCI Clocks w/external Stop control and serial config individual enable/disable.   |

Example:

- a) if MODE = 1, pins 26 and 27 are configured as SDRAM7 and SDRAM6 respectively.
- b) if MODE = 0, pins 26 and 27 are configured as PCI\_STOP# and CPU\_STOP# respectively.

## Power-On Default Conditions

At power-up and before device programming, all clocks will default to an enabled and “on” condition. The frequencies that are then produced are on the MODE pin as shown in the table below.

| CLOCK     | DEFAULT CONDITION AT POWER-UP |
|-----------|-------------------------------|
| REF (0:1) | 14.31818 MHz                  |
| IOAPIC 0  | 14.31818 MHz                  |
| 48/24 MHz | 48 MHz                        |

## Technical Pin Function Descriptions

### VDD(1,2,3,4)

This is the power supply to the internal core logic of the device as well as the clock output buffers for REF(0:1), PCICLK, 48/24MHzA/B and SDRAM(0:7).

This pin operates at 3.3V volts. Clocks from the listed buffers that it supplies will have a voltage swing from Ground to this level. For the actual guaranteed high and low voltage levels for the Clocks, please consult the DC parameter table in this data sheet.

### VDDL1,2

This is the power supplies for the CPUCLK and IOAPIC output buffers. The voltage level for these outputs may be 2.5 or 3.3volts. Clocks from the buffers that each supplies will have a voltage swing from Ground to this level. For the actual Guaranteed high and low voltage levels of these Clocks, please consult the DC parameter table in this Data Sheet.

### GND

This is the power supply ground (common or negative) return pin for the internal core logic and all the output buffers.

### X1

This input pin serves one of two functions. When the device is used with a Crystal, X1 acts as the input pin for the reference signal that comes from the discrete crystal. When the device is driven by an external clock signal, X1 is the device input pin for that reference clock. This pin also implements an internal Crystal loading capacitor that is connected to ground. See the data tables for the value of this capacitor.

### X2

This Output pin is used only when the device uses a Crystal as the reference frequency source. In this mode of operation, X2 is an output signal that drives (or excites) the discrete Crystal. The X2 pin will also implement an internal Crystal loading capacitor that is connected to ground. See the Data Sheet for the value of this capacitor.

### CPUCLK (0:3)

These Output pins are the Clock Outputs that drive processor and other CPU related circuitry that requires clocks which are in tight skew tolerance with the CPU clock. The voltage swing of these Clocks are controlled by the Voltage level applied to the VDDL2 pin of the

device. See the Functionality Table for a list of the specific frequencies that are available for these Clocks and the selection codes to produce them.

### SDRAM(0:7)

These Output Clocks are use to drive Dynamic RAM's and are low skew copies of the CPU Clocks. The voltage swing of the SDRAM's output is controlled by the supply voltage that is applied to VDD3 of the device, operates at 3.3 volts.

### 48/24MHzA, B

This is a fixed frequency Clock output that is typically used to drive Super I/O devices. Outputs A and B are defined as 24 or 48MHz by I<sup>2</sup>C register (see table).

### IOAPIC

This Output is a fixed frequency Output Clock that runs at the Reference Input (typically 14.31818MHz) . Its voltage level swing is controlled by VDDL1 and may operate at 2.5 or 3.3volts.

### REF(0:1)

The REF Outputs are fixed frequency Clocks that run at the same frequency as the Input Reference Clock X1 or the Crystal (typically 14.31818MHz) attached across X1 and X2.

### PCICLK\_F

This Output is equal to PCICLK(0:5) and is FREE RUNNING, and will not be stopped by PCI\_STP#.

### PCICLK (0:5)

These Output Clocks generate all the PCI timing requirements for a Pentium/Pro based system. They conform to the current PCI specification. They run at 1/2 CPU frequency.

### SELECT 66.6/60MHz#

This Input pin controls the frequency of the Clocks at the CPU, PCICLK and SDRAM output pins. If a logic "1" value is present on this pin, the 66.6 MHz Clock will be selected. If a logic "0" is used, the 60MHz frequency will be selected.

## Technical Pin Function Descriptions

### MODE

This Input pin is used to select the Input function of the I/O pins. An active Low will place the I/O pins in the Input mode and enable those stop clock functions.

### CPU3.3\_2.5#

This Input pin controls the CPU and IOAPIC output buffer strength for skew matching CPU and SDRAM outputs to compensate for the external VDDL supply condition. It is important to use this function when selecting power supply requirements for VDDL1,2. A logic "0" (ground) will indicate 2.5V operation and a logic "1" will indicate 3.3V operation. This pin has an internal pullup resistor to VDD.

### PWR\_DWN#

This is an asynchronous active Low Input pin used to Power Down the device into a Low Power state by not removing the power supply. The internal Clocks are disabled and the VCO and Crystal are stopped. Powered Down will also place all the Outputs in a low state at the end of their current cycle. The latency of Power Down will not be greater than 3ms. The I<sup>2</sup>C inputs will be Tri-Stated and the device will retain all programming information. This input pin only valid when MODE=0 (Power Management Mode)

### CPU\_STOP#

This is a synchronous active Low Input pin used to stop the CPUCLK clocks in an active low state. All other Clocks including SDRAM clocks will continue to run while this function is enabled. The CPUCLK's will have a turn ON latency of at least 3 CPU clocks. This input pin only valid when MODE=0 (Power Management Mode)

### PCI\_STOP#

This is a synchronous active Low Input pin used to stop the PCICLK clocks in an active low state. It will not effect PCICLK\_F nor any other outputs. This input pin only valid when MODE=0 (Power Management Mode)

### I<sup>2</sup>C

The SDATA and SCLOCK Inputs are use to program the device. The clock generator is a slave-receiver device in the I<sup>2</sup>C protocol. It will allow read-back of the registers. See configuration map for register functions. The I<sup>2</sup>C specification in Philips I<sup>2</sup>C Peripherals Data Handbook (1996) should be followed.

## General I<sup>2</sup>C serial interface information

The information in this section assumes familiarity with I<sup>2</sup>C programming.  
For more information, contact ICS for an I<sup>2</sup>C programming application note.

### How to Write:

- Controller (host) sends a start bit.
- Controller (host) sends the write address D2<sub>(H)</sub>
- ICS clock will **acknowledge**
- Controller (host) sends a dummy command code
- ICS clock will **acknowledge**
- Controller (host) sends a dummy byte count
- ICS clock will **acknowledge**
- Controller (host) starts sending first byte (Byte 0) through byte 5
- ICS clock will **acknowledge** each byte *one at a time*.
- Controller (host) sends a Stop bit

| How to Write:             |                      |
|---------------------------|----------------------|
| Controller (Host)         | ICS (Slave/Receiver) |
| Start Bit                 |                      |
| Address D2 <sub>(H)</sub> |                      |
|                           | <b>ACK</b>           |
| Dummy Command Code        |                      |
|                           | <b>ACK</b>           |
| Dummy Byte Count          |                      |
|                           | <b>ACK</b>           |
| Byte 0                    |                      |
|                           | <b>ACK</b>           |
| Byte 1                    |                      |
|                           | <b>ACK</b>           |
| Byte 2                    |                      |
|                           | <b>ACK</b>           |
| Byte 3                    |                      |
|                           | <b>ACK</b>           |
| Byte 4                    |                      |
|                           | <b>ACK</b>           |
| Byte 5                    |                      |
|                           | <b>ACK</b>           |
| Stop Bit                  |                      |

### How to Read:

- Controller (host) will send start bit.
- Controller (host) sends the read address D3<sub>(H)</sub>
- ICS clock will **acknowledge**
- ICS clock will send the **byte count**
- Controller (host) acknowledges
- ICS clock sends first byte (**Byte 0**) through **byte 5**
- Controller (host) will need to acknowledge each byte
- Controller (host) will send a stop bit

| How to Read:              |                      |
|---------------------------|----------------------|
| Controller (Host)         | ICS (Slave/Receiver) |
| Start Bit                 |                      |
| Address D3 <sub>(H)</sub> |                      |
|                           | <b>ACK</b>           |
|                           | <b>Byte Count</b>    |
| ACK                       |                      |
|                           | <b>Byte 0</b>        |
| ACK                       |                      |
|                           | <b>Byte 1</b>        |
| ACK                       |                      |
|                           | <b>Byte 2</b>        |
| ACK                       |                      |
|                           | <b>Byte 3</b>        |
| ACK                       |                      |
|                           | <b>Byte 4</b>        |
| ACK                       |                      |
|                           | <b>Byte 5</b>        |
| ACK                       |                      |
| Stop Bit                  |                      |

### Notes:

1. The ICS clock generator is a slave/receiver, I<sup>2</sup>C component. It can read back the data stored in the latches for verification. **Read-Back will support Intel PIIX4 "Block-Read" protocol.**
2. The data transfer rate supported by this clock generator is 100K bits/sec or less (standard mode)
3. The input is operating at 3.3V logic levels.
4. The data byte format is 8 bit bytes.
5. To simplify the clock generator I<sup>2</sup>C interface, the protocol is set to use only "**Block-Writes**" from the controller. The bytes must be accessed in sequential order from lowest to highest byte with the ability to stop after any complete byte has been transferred. The Command code and Byte count shown above must be sent, but the data is ignored for those two bytes. The data is loaded until a Stop sequence is issued.
6. At power-on, all registers are set to a default condition, as shown.

## Select Functions

| Functionality | CPU                 | PCI,<br>PCI_F       | SDRAM               | REF               | IOAPIC            | 24 MHz<br>Selection | 48 MHz<br>Selection |
|---------------|---------------------|---------------------|---------------------|-------------------|-------------------|---------------------|---------------------|
| Tristate      | HI - Z              | HI - Z              | HI - Z              | HI - Z            | HI - Z            | HI - Z              | HI - Z              |
| Testmode      | TCLK/2 <sup>1</sup> | TCLK/4 <sup>1</sup> | TCLK/2 <sup>1</sup> | TCLK <sup>1</sup> | TCLK <sup>1</sup> | TCLK/4 <sup>1</sup> | TCLK/2 <sup>1</sup> |

### Notes:

1. TCLK is a test clock driven on the X1 (crystal in pin) input during test mode.

## Serial Configuration Command Bitmaps

**Byte 0: Functional and Frequency Select Clock Register (default on Bits 7, 6, 5, 4, 1, 0 = 0)**

**Note:** PWD = Power-Up Default (default on Bits 3, 2 = 1)

| BIT            | PIN# | DESCRIPTION   | PWD    |
|----------------|------|---|--------|
| Bit 7          | -    | Reserved  | 0      |
| Bit 6          | -    | Must be 0 for normal operation  | 0      |
| Bit 5          | -    | In Spread Spectrum, Controls type<br>(0=centered, 1=down spread)  | 0      |
| Bit 4          | -    | In Spread Spectrum, Controls Spreading<br>(0=1.8% 1=0.6%)   | 0      |
| Bit 3          | 23   | 48/24 MHz (Frequency Select) 1=48 MHz, 0=24 MHz   | 1      |
| Bit 2          | 22   | 48/24 MHz (Frequency Select) 1=48 MHz, 0=24 MHz   | 1      |
| Bit 1<br>Bit 0 | -    | <div> <div>Bit1</div> <div>Bit0</div> <div>1 1 - Tri-State</div> <div>1 0 - Spread Spectrum Enable</div> <div>0 1 - Testmode</div> <div>0 0 - Normal operation</div> </div> | 0<br>0 |



### Byte 1: CPU, 24/48 MHz Clock Register

| BIT   | PIN# | PWD | DESCRIPTION           |
|-------|------|-----|-----------------------|
| Bit 7 | 23   | 1   | 48/24 MHz (Act/Inact) |
| Bit 6 | 22   | 1   | 48/24 MHz (Act/Inact) |
| Bit 5 | -    | 1   | Reserved              |
| Bit 4 | -    | 1   | Reserved              |
| Bit 3 | 38   | 1   | CPUCLK3 (Act/Inact)   |
| Bit 2 | 39   | 1   | CPUCLK2 (Act/Inact)   |
| Bit 1 | 41   | 1   | CPUCLK1 (Act/Inact)   |
| Bit 0 | 42   | 1   | CPUCLK0 (Act/Inact)   |

**Notes:** 1 = Enabled; 0 = Disabled, outputs held low

### Byte 2: PCICLK Clock Register

| BIT   | PIN# | PWD | DESCRIPTION          |
|-------|------|-----|----------------------|
| Bit 7 | -    | 1   | Reserved             |
| Bit 6 | 8    | 1   | PCICLK_F (Act/Inact) |
| Bit 5 | 16   | 1   | PCICLK5 (Act/Inact)  |
| Bit 4 | 14   | 1   | PCICLK4 (Act/Inact)  |
| Bit 3 | 13   | 1   | PCICLK3 (Act/Inact)  |
| Bit 2 | 12   | 1   | PCICLK2 (Act/Inact)  |
| Bit 1 | 11   | 1   | PCICLK1 (Act/Inact)  |
| Bit 0 | 9    | 1   | PCICLK0 (Act/Inact)  |

**Notes:** 1 = Enabled; 0 = Disabled, outputs held low

### Byte 3: SDRAM Clock Register

| BIT   | PIN# | PWD | DESCRIPTION        |
|-------|------|-----|--------------------|
| Bit 7 | 26   | 1   | SDRAM7 (Act/Inact) |
| Bit 6 | 27   | 1   | SDRAM6 (Act/Inact) |
| Bit 5 | 29   | 1   | SDRAM5 (Act/Inact) |
| Bit 4 | 30   | 1   | SDRAM4 (Act/Inact) |
| Bit 3 | 32   | 1   | SDRAM3 (Act/Inact) |
| Bit 2 | 33   | 1   | SDRAM2 (Act/Inact) |
| Bit 1 | 35   | 1   | SDRAM1 (Act/Inact) |
| Bit 0 | 36   | 1   | SDRAM0 (Act/Inact) |

**Notes:** 1 = Enabled; 0 = Disabled, outputs held low

### Byte 4: SDRAM Clock Register

| BIT   | PIN# | PWD | DESCRIPTION |
|-------|------|-----|-------------|
| Bit 7 | -    | 1   | Reserved    |
| Bit 6 | -    | 1   | Reserved    |
| Bit 5 | -    | 1   | Reserved    |
| Bit 4 | -    | 1   | Reserved    |
| Bit 3 | -    | 1   | Reserved    |
| Bit 2 | -    | 1   | Reserved    |
| Bit 1 | -    | 1   | Reserved    |
| Bit 0 | -    | 1   | Reserved    |

**Notes:** 1 = Enabled; 0 = Disabled, outputs held low

### Byte 5: Peripheral Clock Register

| BIT   | PIN# | PWD | DESCRIPTION         |
|-------|------|-----|---------------------|
| Bit 7 | -    | 1   | Reserved            |
| Bit 6 | -    | 1   | Reserved            |
| Bit 5 | -    | 1   | Reserved            |
| Bit 4 | 45   | 1   | IOAPIC0 (Act/Inact) |
| Bit 3 | -    | 1   | Reserved            |
| Bit 2 | -    | 1   | Reserved            |
| Bit 1 | 1    | 1   | REF1 (Act/Inact)    |
| Bit 0 | 2    | 1   | REF0 (Act/Inact)    |

**Notes:** 1 = Enabled; 0 = Disabled, outputs held low  
**Note:** PWD = Power-Up Default

### Byte 6: Optional Register for Future

| BIT   | PIN# | PWD | DESCRIPTION |
|-------|------|-----|-------------|
| Bit 7 | -    | 1   | Reserved    |
| Bit 6 | -    | 1   | Reserved    |
| Bit 5 | -    | 1   | Reserved    |
| Bit 4 | -    | 1   | Reserved    |
| Bit 3 | -    | 1   | Reserved    |
| Bit 2 | -    | 1   | Reserved    |
| Bit 1 | -    | 1   | Reserved    |
| Bit 0 | -    | 1   | Reserved    |

**Notes:**  
1. Byte 6 is reserved by Integrated Circuit Systems for future applications.

**Note:** PWD = Power-Up Default

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## Power Management

### Clock Enable Configuration

| CPU_STOP# | PCI_STOP# | PWR_DWN# | CPUCLK      | PCICLK      | Other Clocks,<br>SDRAM,<br>REF,<br>IOAPICs,<br>48/24 MHz A<br>48/24 MHz B | Crystal | VCOs    |
|-----------|-----------|----------|-------------|-------------|---|---------|---------|
| X         | X         | 0        | Low         | Low         | Stopped   | Off     | Off     |
| 0         | 0         | 1        | Low         | Low         | Running   | Running | Running |
| 0         | 1         | 1        | Low         | 33.3/30 MHz | Running   | Running | Running |
| 1         | 0         | 1        | 66.6/60 MHz | Low         | Running   | Running | Running |
| 1         | 1         | 1        | 66.6/60 MHz | 33.3/30 MHz | Running   | Running | Running |

Full clock cycle timing is guaranteed at all times after the system has initially powered up except where noted. During power up and power down operations using the PWR PD# select pin will not cause clocks of a short or longer pulse than that of the running clock. The first clock pulse coming out of a stopped clock condition may be slightly distorted due to clock network charging circuitry. Board routing and signal loading may have a large impact on the initial clock distortion also.

### ICS9148-12 Power Management Requirements

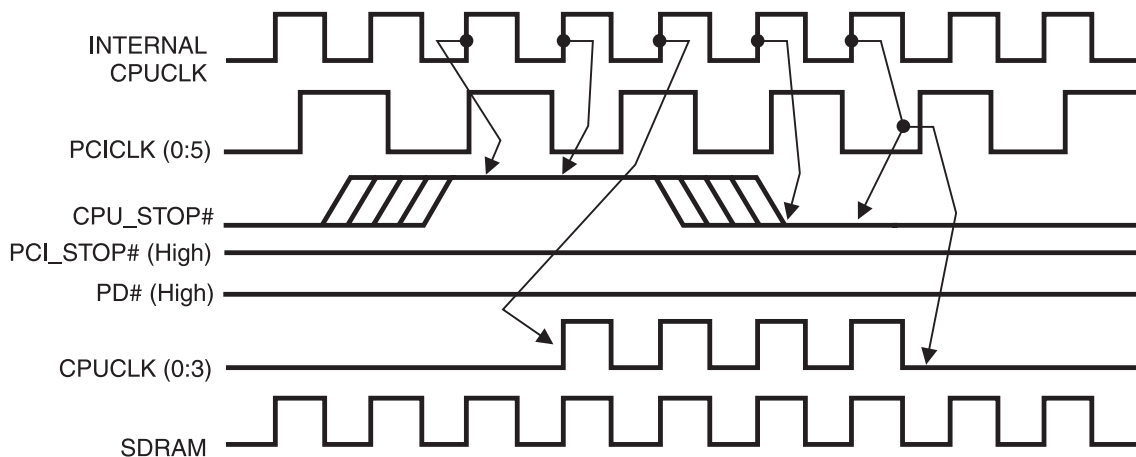
| SIGNAL    | SIGNAL STATE                      | Latency<br>No. of rising edges of free running<br>PCICLK |
|-----------|-----------------------------------|--|
| CPU_STOP# | 0 (Disabled) <sup>2</sup>         | 1  |
|           | 1 (Enabled) <sup>1</sup>          | 1  |
| PCI_STOP# | 0 (Disabled) <sup>2</sup>         | 1  |
|           | 1 (Enabled) <sup>1</sup>          | 1  |
| PWR_DWN#  | 1 (Normal Operation) <sup>3</sup> | 3mS  |
|           | 0 (Power Down) <sup>4</sup>       | 2max   |

#### Notes.

1. Clock on latency is defined from when the clock enable goes active to when the first valid clock comes out of the device.
2. Clock off latency is defined from when the clock enable goes inactive to when the last clock is driven low out of the device.
3. Power up latency is when PD# goes inactive (high) to when the first valid clocks are output by the device.
4. Power down has controlled clock counts applicable to CPUCLK, SDRAM, PCICLK only.  
The REF and IOAPIC will be stopped independant of these.

## CPU\_STOP# Timing Diagram

CPUSTOP# is an asynchronous input to the clock synthesizer. It is used to turn off the CPUCLKs for low power operation. CPU\_STOP# is synchronized by the **ICS9148-12**. The minimum that the CPUCLK is enabled (CPU\_STOP# high pulse) is 100 CPUCLKs. All other clocks will continue to run while the CPUCLKs are disabled. The CPUCLKs will always be stopped in a low state and start in such a manner that guarantees the high pulse width is a full pulse. CPUCLK on latency is less than 4 CPUCLKs and CPUCLK off latency is less than 4 CPUCLKs.



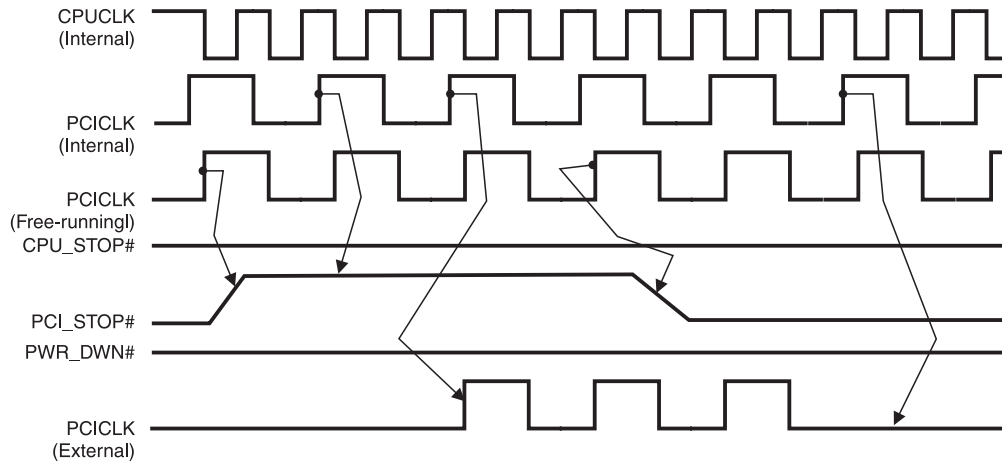
### Notes:

1. All timing is referenced to the internal CPUCLK.
2. CPU\_STOP# is an asynchronous input and metastable conditions may exist. This signal is synchronized to the CPUCLKs inside the **ICS9148-12**.
3. All other clocks continue to run undisturbed.
4. PD# and PCI\_STOP# are shown in a high (true) state.

## PCI\_STOP# Timing Diagram

PCI\_STOP# is an asynchronous input to the **ICS9148-12**. It is used to turn off the PCICLK (0:5) clocks for low power operation. PCI\_STOP# is synchronized by the **ICS9148-12** internally. The minimum that the PCICLK (0:5) clocks are enabled (PCI\_STOP# high pulse) is at least 10 PCICLK (0:5) clocks. PCICLK (0:5) clocks are stopped in a low state and started with a full high pulse width guaranteed. PCICLK (0:5) clock on latency cycles are only one rising PCICLK clock off latency is one PCICLK clock.

(Drawing shown on next page.)

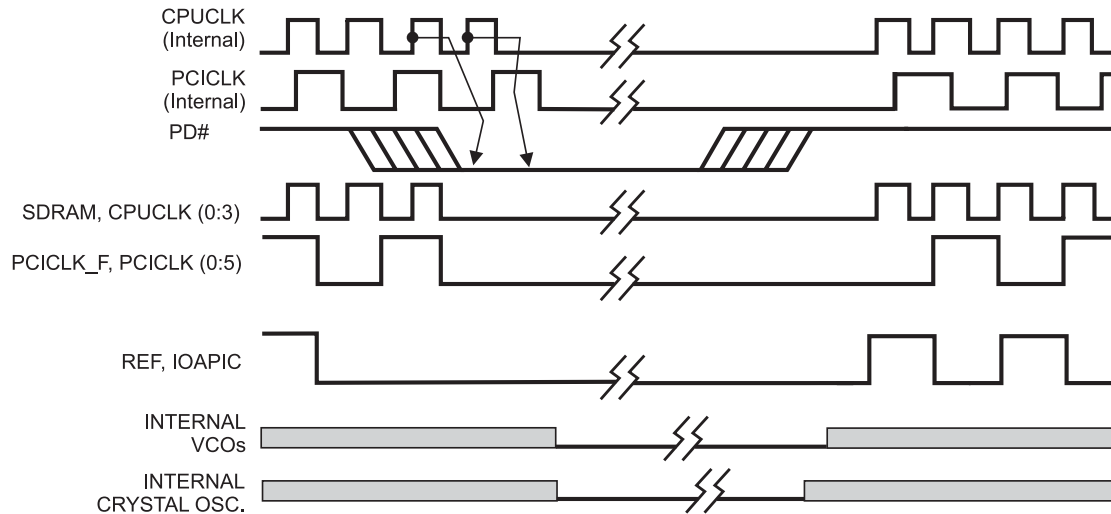


**Notes:**

1. All timing is referenced to the Internal CPUCLK (defined as inside the ICS9148 device.)
2. PCI\_STOP# is an asynchronous input, and metastable conditions may exist. This signal is required to be synchronized inside the ICS9148.
3. All other clocks continue to run undisturbed.
4. PD# and CPU\_STOP# are shown in a high (true) state.

## PD# Timing Diagram

The power down selection is used to put the part into a very low power state without turning off the power to the part. PD# is an asynchronous active low input. This signal is synchronized internal by the **ICS9148-12** prior to its control action of powering down the clock synthesizer. Internal clocks will not be running after the device is put in power down state. When PD# is active (low) all clocks are driven to a low state and held prior to turning off the VCOs and the Crystal oscillator. The power on latency is guaranteed to be less than 3mS. The power down latency is less than three CPUCLK cycles. PCI\_STOP# and CPU\_STOP# are don't care signals during the power down operations.



**Notes:**

1. All timing is referenced to the Internal CPUCLK (defined as inside the ICS9148 device).
2. PD# is an asynchronous input and metastable conditions may exist. This signal is synchronized inside the ICS9148.
3. The shaded sections on the VCO and the Crystal signals indicate an active clock is being generated.

## Absolute Maximum Ratings

|                               |                                |
|-------------------------------|--------------------------------|
| Supply Voltage                | 7.0 V                          |
| Logic Inputs                  | GND –0.5 V to $V_{DD} + 0.5$ V |
| Ambient Operating Temperature | 0°C to +70°C                   |
| Case Temperature              | 115°C                          |
| Storage Temperature           | –65°C to +150°C                |

Stresses above those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stress specifications only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

## Electrical Characteristics - Input/Supply/Common Output Parameters

$T_A = 0 - 70^\circ\text{C}$ ; Supply Voltage  $V_{DD} = V_{DDL} = 3.3$  V  $\pm 5\%$  (unless otherwise stated)

| PARAMETER                      | SYMBOL           | CONDITIONS                                       | MIN            | TYP    | MAX            | UNITS |
|--------------------------------|------------------|--|----------------|--------|----------------|-------|
| Input High Voltage             | $V_{IH}$         |  | 2              |        | $V_{DD} + 0.3$ | V     |
| Input Low Voltage              | $V_{IL}$         |  | $V_{SS} - 0.3$ |        | 0.8            | V     |
| Input High Current             | $I_{IH}$         | $V_{IN} = V_{DD}$                                |                | 0.1    | 5              | mA    |
| Input Low Current              | $I_{IL1}$        | $V_{IN} = 0$ V; Inputs with no pull-up resistors | -5             | 2.0    |                | mA    |
| Input Low Current              | $I_{IL2}$        | $V_{IN} = 0$ V; Inputs with pull-up resistors    | -200           | -100   |                | mA    |
| Operating Supply Current       | $I_{DD3.3OP}$    | $C_L = 0$ pF; Select @ 66M                       |                | 60     | 100            | mA    |
| Power Down Supply Current      | $I_{DD3.3PD}$    | $C_L = 0$ pF; With input address to Vdd or GND   |                | 400    | 600            | mA    |
| Input frequency                | $F_i$            | $V_{DD} = 3.3$ V;                                |                | 14.318 |                | MHz   |
| Input Capacitance <sup>1</sup> | $C_{IN}$         | Logic Inputs                                     |                |        | 5              | pF    |
|                                | $C_{INX}$        | X1 & X2 pins                                     | 27             | 36     | 45             | pF    |
| Transition Time <sup>1</sup>   | $T_{trans}$      | To 1st crossing of target Freq.                  |                |        | 3              | ms    |
| Settling Time <sup>1</sup>     | $T_s$            | From 1st crossing to 1% target Freq.             |                |        |                | ms    |
| Clk Stabilization <sup>1</sup> | $T_{STAB}$       | From $V_{DD} = 3.3$ V to 1% target Freq.         |                |        | 3              | mS    |
| Skew <sup>1</sup>              | $T_{CPU-SDRAM1}$ | $V_T = 1.5$ V                                    |                | 200    | 500            | ps    |
|                                | $T_{CPU-PCI1}$   | $V_T = 1.5$ V;                                   | 1.5            | 3.2    | 4.5            | ns    |

<sup>1</sup>Guaranteed by design, not 100% tested in production.

## Electrical Characteristics - Input/Supply/Common Output Parameters

$T_A = 0 - 70^\circ\text{C}$ ; Supply Voltage  $V_{DD} = 3.3$  V  $\pm 5\%$ ,  $V_{DDL} = 2.5$  V  $\pm 5\%$  (unless otherwise stated)

| PARAMETER                 | SYMBOL           | CONDITIONS                                    | MIN | TYP  | MAX | UNITS |
|---------------------------|------------------|---|-----|------|-----|-------|
| Operating Supply Current  | $I_{DD2.5OP}$    | $C_L = 0$ pF; Select @ 66M                    |     | 5    | 20  | mA    |
| Power Down Supply Current | $I_{DD2.5PD}$    | $C_L = 0$ pF;                                 |     | 0.21 | 1.0 | mA    |
| Skew <sup>1</sup>         | $T_{CPU-SDRAM2}$ | $V_T = 1.5$ V; $V_{TL} = 1.25$ V; SDRAM Leads |     | 150  | 500 | ps    |
|                           | $T_{CPU-PCI2}$   | $V_T = 1.5$ V; $V_{TL} = 1.25$ V; CPU Leads   | 1   | 2.8  | 4   | ns    |

<sup>1</sup>Guaranteed by design, not 100% tested in production.

## Electrical Characteristics - CPU

$T_A = 0 - 70^\circ\text{C}$ ;  $V_{DD} = V_{DDL} = 3.3\text{ V} \pm 5\%$ ;  $C_L = 10 - 20\text{ pF}$  (unless otherwise stated)

| PARAMETER           | SYMBOL                    | CONDITIONS  | MIN  | TYP  | MAX  | UNITS    |
|---------------------|---------------------------|---|------|------|------|----------|
| Output Frequency    | $F_{O2}$                  |   | 60   |      | 66   | MHz      |
| Output Impedance    | $R_{DSP2A}^1$             | $V_O = V_{DD} \cdot (0.5)$                        | 10   |      | 20   | $\Omega$ |
| Output Impedance    | $R_{DSN2A}^1$             | $V_O = V_{DD} \cdot (0.5)$                        | 10   |      | 20   | $\Omega$ |
| Output High Voltage | $V_{OH2A}$                | $I_{OH} = -28\text{ mA}$                          | 2.4  | 2.5  |      | V        |
| Output Low Voltage  | $V_{OL2A}$                | $I_{OL} = 27\text{ mA}$                           |      | 0.35 | 0.4  | V        |
| Output High Current | $I_{OH2A}$                | $V_{OH} = 2.0\text{ V}$                           |      | -52  | -48  | mA       |
| Output Low Current  | $I_{OL2A}$                | $V_{OL} = 0.8\text{ V}$                           | 49.3 | 59   |      | mA       |
| Rise Time           | $t_{r2A}^1$               | $V_{OL} = 0.4\text{ V}$ , $V_{OH} = 2.4\text{ V}$ |      | 1.1  | 2.85 | ns       |
| Fall Time           | $t_{f2A}^1$               | $V_{OH} = 2.4\text{ V}$ , $V_{OL} = 0.4\text{ V}$ |      | 0.95 | 2.85 | ns       |
| Duty Cycle          | $d_{t2A}^1$               | $V_T = 1.5\text{ V}$                              | 45   | 51   | 55   | %        |
| Skew                | $t_{sk2A}^1$              | $V_T = 1.5\text{ V}$                              |      | 80   | 250  | ps       |
| Jitter              | $t_{j\text{cyc-cyc}2A}^1$ | $V_T = 1.5\text{ V}$                              |      | 170  | 250  | ps       |
|                     | $t_{j1s2A}^1$             | $V_T = 1.5\text{ V}$                              |      | 60   | 150  | ps       |
|                     | $t_{jabs2A}^1$            | $V_T = 1.5\text{ V}$                              | -250 | 100  | +250 | ps       |

<sup>1</sup>Guaranteed by design, not 100% tested in production.

## Electrical Characteristics - CPU

$T_A = 0 - 70^\circ\text{C}$ ;  $V_{DD} = 3.3\text{ V} \pm 5\%$ ,  $V_{DDL} = 2.5\text{ V} \pm 5\%$ ;  $C_L = 10 - 20\text{ pF}$  (unless otherwise stated)

| PARAMETER           | SYMBOL                    | CONDITIONS  | MIN  | TYP  | MAX  | UNITS    |
|---------------------|---------------------------|---|------|------|------|----------|
| Output Frequency    | $F_{O2}$                  |   | 60   |      | 66   | MHz      |
| Output Impedance    | $R_{DSP2B}^1$             | $V_O = V_{DD} \cdot (0.5)$                        | 10   |      | 20   | $\Omega$ |
| Output Impedance    | $R_{DSN2B}^1$             | $V_O = V_{DD} \cdot (0.5)$                        | 10   |      | 20   | $\Omega$ |
| Output High Voltage | $V_{OH2B}$                | $I_{OH} = -8.0\text{ mA}$                         | 2.1  | 2.15 |      | V        |
| Output Low Voltage  | $V_{OL2B}$                | $I_{OL} = 21\text{ mA}$                           |      | 0.3  | 0.4  | V        |
| Output High Current | $I_{OH2B}$                | $V_{OH} = 1.8\text{ V}$                           |      | -22  | -18  | mA       |
| Output Low Current  | $I_{OL2B}$                | $V_{OL} = 0.5\text{ V}$                           | 33   | 36   |      | mA       |
| Rise Time           | $t_{r2B}^1$               | $V_{OL} = 0.4\text{ V}$ , $V_{OH} = 2.0\text{ V}$ |      | 1.2  | 1.5  | ns       |
| Fall Time           | $t_{f2B}^1$               | $V_{OH} = 2.0\text{ V}$ , $V_{OL} = 0.4\text{ V}$ |      | 0.95 | 1.3  | ns       |
| Duty Cycle          | $d_{t2B}^1$               | $V_T = 1.25\text{ V}$                             | 45   | 50   | 55   | ns       |
| Skew                | $t_{sk2B}^1$              | $V_T = 1.25\text{ V}$                             |      | 60   | 250  | ps       |
| Jitter              | $t_{j\text{cyc-cyc}2B}^1$ | $V_T = 1.25\text{ V}$                             |      | 150  | 250  | ps       |
|                     | $t_{j1s2B}^1$             | $V_T = 1.25\text{ V}$                             |      | 50   | 150  | ps       |
|                     | $t_{jabs2B}^1$            | $V_T = 1.25\text{ V}$                             | -250 | 80   | +250 | ps       |

<sup>1</sup>Guaranteed by design, not 100% tested in production.

## Electrical Characteristics - PCI

$T_A = 0 - 70^\circ\text{C}$ ;  $V_{DD} = V_{DDL} = 3.3 \text{ V} \pm 5\%$ ;  $C_L = 30 \text{ pF}$  (unless otherwise stated)

| PARAMETER           | SYMBOL        | CONDITIONS  | MIN  | TYP  | MAX | UNITS    |
|---------------------|---------------|---|------|------|-----|----------|
| Output Frequency    | $F_{O1}$      |   | 30   | -    | 33  | MHz      |
| Output Impedance    | $R_{DSP1}^1$  | $V_O = V_{DD}^*(0.5)$                               | 12   |      | 55  | $\Omega$ |
| Output Impedance    | $R_{DSN1}^1$  | $V_O = V_{DD}^*(0.5)$                               | 12   |      | 55  | $\Omega$ |
| Output High Voltage | $V_{OH1}$     | $I_{OH} = -14.5 \text{ mA}$                         | 2.4  | 2.7  |     | V        |
| Output Low Voltage  | $V_{OL1}$     | $I_{OL} = 9.4 \text{ mA}$                           |      | 0.2  | 0.4 | V        |
| Output High Current | $I_{OH1}$     | $V_{OH} = 2.0 \text{ V}$                            |      | -47  | -22 | mA       |
| Output Low Current  | $I_{OL1}$     | $V_{OL} = 0.8 \text{ V}$                            | 17.1 | 47.5 |     | mA       |
| Rise Time           | $t_{r1}^1$    | $V_{OL} = 0.4 \text{ V}$ , $V_{OH} = 2.4 \text{ V}$ |      | 1.5  | 2   | ns       |
| Fall Time           | $t_{f1}^1$    | $V_{OH} = 2.4 \text{ V}$ , $V_{OL} = 0.4 \text{ V}$ |      | 1.1  | 2   | ns       |
| Duty Cycle          | $d_{t1}^1$    | $V_T = 1.5 \text{ V}$                               | 45   | 51   | 55  | %        |
| Skew                | $t_{sk1}^1$   | $V_T = 1.5 \text{ V}$                               |      | 100  | 250 | ps       |
| Jitter              | $t_{j1s1}^1$  | $V_T = 1.5 \text{ V}$                               |      | 50   | 150 | ps       |
|                     | $t_{jabs1}^1$ | $V_T = 1.5 \text{ V}$                               | -250 | 120  | 250 | ps       |

<sup>1</sup>Guaranteed by design, not 100% tested in production.

## Electrical Characteristics - SDRAM

$T_A = 0 - 70^\circ\text{C}$ ;  $V_{DD} = V_{DDL} = 3.3 \text{ V} \pm 5\%$ ;  $C_L = 20 - 30 \text{ pF}$  (unless otherwise stated)

| PARAMETER           | SYMBOL        | CONDITIONS  | MIN  | TYP  | MAX | UNITS    |
|---------------------|---------------|---|------|------|-----|----------|
| Output Frequency    | $F_{O3}$      |   | 60   |      | 66  | MHz      |
| Output Impedance    | $R_{DSP3}^1$  | $V_O = V_{DD}^*(0.5)$                               | 10   |      | 24  | $\Omega$ |
| Output Impedance    | $R_{DSN3}^1$  | $V_O = V_{DD}^*(0.5)$                               | 10   |      | 24  | $\Omega$ |
| Output High Voltage | $V_{OH3}$     | $I_{OH} = -24 \text{ mA}$                           | 2.4  | 2.5  |     | V        |
| Output Low Voltage  | $V_{OL3}$     | $I_{OL} = 23 \text{ mA}$                            |      | 0.35 | 0.4 | V        |
| Output High Current | $I_{OH3}$     | $V_{OH} = 2.0 \text{ V}$                            |      | -47  | -40 | mA       |
| Output Low Current  | $I_{OL3}$     | $V_{OL} = 0.8 \text{ V}$                            | 41   | 47.5 |     | mA       |
| Rise Time           | $T_{r3}^1$    | $V_{OL} = 0.4 \text{ V}$ , $V_{OH} = 2.4 \text{ V}$ |      | 1.45 | 1.7 | ns       |
| Fall Time           | $T_{f3}^1$    | $V_{OH} = 2.4 \text{ V}$ , $V_{OL} = 0.4 \text{ V}$ |      | 1.2  | 1.5 | ns       |
| Duty Cycle          | $D_{t3}^1$    | $V_T = 1.5 \text{ V}$                               | 45   | 51   | 55  | %        |
| Skew                | $T_{sk3}^1$   | $V_T = 1.5 \text{ V}$                               |      | 80   | 250 | ps       |
| Jitter              | $T_{j1s3}^1$  | $V_T = 1.5 \text{ V}$                               |      | 40   | 150 | ps       |
|                     | $T_{jabs3}^1$ | $V_T = 1.5 \text{ V}$                               | -250 | -    | 250 | ps       |

<sup>1</sup>Guaranteed by design, not 100% tested in production.

## Electrical Characteristics - IOAPIC

$T_A = 0 - 70^\circ\text{C}$ ;  $V_{DD} = V_{DDL} = 3.3 \text{ V} \pm 5\%$ ;  $C_L = 10 - 20 \text{ pF}$  (unless otherwise stated)

| PARAMETER           | SYMBOL         | CONDITIONS  | MIN  | TYP    | MAX | UNITS    |
|---------------------|----------------|---|------|--------|-----|----------|
| Output Frequency    | $F_{O4}$       |   |      | 14.318 |     | MHz      |
| Output Impedance    | $R_{DSP4A}^1$  | $V_O = V_{DD} \cdot (0.5)$                          | 10   |        | 30  | $\Omega$ |
| Output Impedance    | $R_{DSN4A}^1$  | $V_O = V_{DD} \cdot (0.5)$                          | 10   |        | 30  | $\Omega$ |
| Output High Voltage | $V_{OH4A}$     | $I_{OH} = -13 \text{ mA}$                           | 2.5  | 2.6    |     | V        |
| Output Low Voltage  | $V_{OL4A}$     | $I_{OL} = 18 \text{ mA}$                            |      | 0.35   | 0.4 | V        |
| Output High Current | $I_{OH4A}$     | $V_{OH} = 2.0 \text{ V}$                            |      | -29    | -23 | mA       |
| Output Low Current  | $I_{OL4A}$     | $V_{OL} = 0.8 \text{ V}$                            | 33   | 37     |     | mA       |
| Rise Time           | $t_{r4A}^1$    | $V_{OL} = 0.4 \text{ V}$ , $V_{OH} = 2.4 \text{ V}$ |      | 1.1    | 2   | ns       |
| Fall Time           | $t_{f4A}^1$    | $V_{OH} = 2.4 \text{ V}$ , $V_{OL} = 0.4 \text{ V}$ |      | 1.6    | 2   | ns       |
| Duty Cycle          | $d_{t4A}^1$    | $V_T = 1.5 \text{ V}$                               | 45   | 51     | 55  | %        |
| Jitter              | $t_{j1s4A}^1$  | $V_T = 1.5 \text{ V}$                               |      | 160    | 350 | ps       |
|                     | $t_{jabs4A}^1$ | $V_T = 1.5 \text{ V}$                               | -600 | -      | 600 | ps       |

<sup>1</sup>Guaranteed by design, not 100% tested in production.

## Electrical Characteristics - IOAPIC

$T_A = 0 - 70^\circ\text{C}$ ;  $V_{DD} = 3.3 \text{ V} \pm 5\%$ ,  $V_{DDL} = 2.5 \text{ V} \pm 5\%$ ;  $C_L = 10 - 20 \text{ pF}$  (unless otherwise stated)

| PARAMETER           | SYMBOL         | CONDITIONS  | MIN  | TYP  | MAX | UNITS    |
|---------------------|----------------|---|------|------|-----|----------|
| Output Frequency    | $F_{O4}$       |   | 60   |      | 66  | MHz      |
| Output Impedance    | $R_{DSP4B}^1$  | $V_O = V_{DD} \cdot (0.5)$                          | 10   |      | 30  | $\Omega$ |
| Output Impedance    | $R_{DSN4B}^1$  | $V_O = V_{DD} \cdot (0.5)$                          | 10   |      | 30  | $\Omega$ |
| Output High Voltage | $V_{OH4B}$     | $I_{OH} = -5.5 \text{ mA}$                          | 2.1  | 2.2  |     | V        |
| Output Low Voltage  | $V_{OL4B}$     | $I_{OL} = 9.0 \text{ mA}$                           |      | 0.25 | 0.3 | V        |
| Output High Current | $I_{OH4B}$     | $V_{OH} = 1.7 \text{ V}$                            |      | -17  | -15 | mA       |
| Output Low Current  | $I_{OL4B}$     | $V_{OL} = 0.7 \text{ V}$                            | 15   | 16   |     | mA       |
| Rise Time           | $t_{r4B}^1$    | $V_{OL} = 0.4 \text{ V}$ , $V_{OH} = 2.0 \text{ V}$ |      | 1.4  | 1.6 | ns       |
| Fall Time           | $t_{f4B}^1$    | $V_{OH} = 2.0 \text{ V}$ , $V_{OL} = 0.4 \text{ V}$ |      | 1.1  | 1.6 | ns       |
| Duty Cycle          | $d_{t4B}^1$    | $V_T = 1.25 \text{ V}$                              | 40   | 53   | 60  | %        |
| Jitter              | $t_{j1s4B}^1$  | $V_T = 1.25 \text{ V}$                              |      | 130  | 300 | ps       |
|                     | $t_{jabs4B}^1$ | $V_T = 1.25 \text{ V}$                              | -700 | -    | 700 | ps       |

<sup>1</sup>Guaranteed by design, not 100% tested in production.



## Electrical Characteristics - REF0

$T_A = 0 - 70^\circ\text{C}$ ;  $V_{DD} = V_{DDL} = 3.3\text{ V} \pm 5\%$ ;  $C_L = 20 - 45\text{ pF}$  (unless otherwise stated)

| PARAMETER           | SYMBOL        | CONDITIONS  | MIN  | TYP    | MAX | UNITS    |
|---------------------|---------------|---|------|--------|-----|----------|
| Output Frequency    | $F_{O7}$      |   |      | 14.318 |     | MHz      |
| Output Impedance    | $R_{DSP7}$    | $V_O = V_{DD}^*(0.5)$                             | 10   |        | 24  | $\Omega$ |
| Output Impedance    | $R_{DSN7}$    | $V_O = V_{DD}^*(0.5)$                             | 10   |        | 24  | $\Omega$ |
| Output High Voltage | $V_{OH7}$     | $I_{OH} = -24\text{ mA}$                          | 2.4  | 2.5    |     | V        |
| Output Low Voltage  | $V_{OL7}$     | $I_{OL} = 23\text{ mA}$                           |      | 0.35   | 0.4 | V        |
| Output High Current | $I_{OH7}$     | $V_{OH} = 2.0\text{ V}$                           |      | -47    | -40 | mA       |
| Output Low Current  | $I_{OL7}$     | $V_{OL} = 0.8\text{ V}$                           | 41   | 47.5   |     | mA       |
| Rise Time           | $T_{r7}^1$    | $V_{OL} = 0.4\text{ V}$ , $V_{OH} = 2.4\text{ V}$ |      | 1.8    | 2   | ns       |
| Fall Time           | $T_{f7}^1$    | $V_{OH} = 2.4\text{ V}$ , $V_{OL} = 0.4\text{ V}$ |      | 1.4    | 2   | ns       |
| Duty Cycle          | $D_{t7}^1$    | $V_T = 1.5\text{ V}$                              | 45   | 52     | 45  | %        |
| Jitter              | $T_{j1s7}^1$  | $V_T = 1.5\text{ V}$                              |      | 150    | 350 | ps       |
|                     | $T_{jabs7}^1$ | $V_T = 1.5\text{ V}$                              | -600 | -      | 600 | ps       |

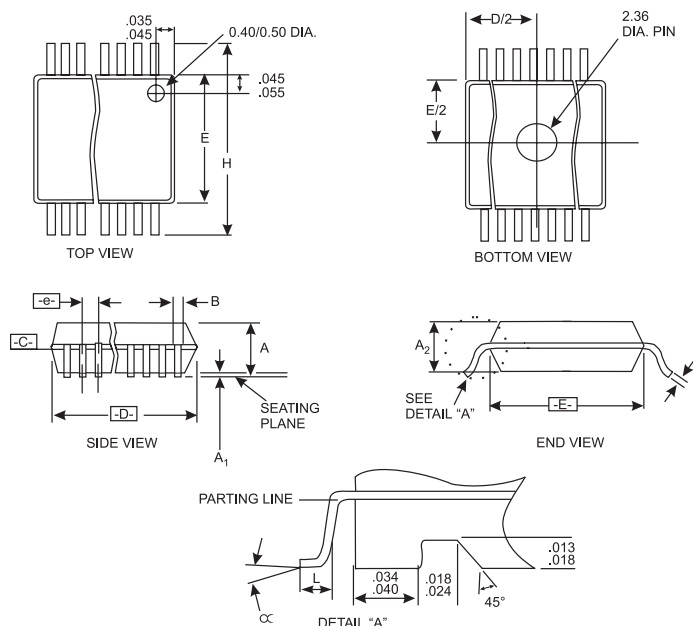
<sup>1</sup>Guaranteed by design, not 100% tested in production.

## Electrical Characteristics - 24M, 48M, REF(1:2)

$T_A = 0 - 70^\circ\text{C}$ ;  $V_{DD} = V_{DDL} = 3.3\text{ V} \pm 5\%$ ;  $C_L = 10 - 20\text{ pF}$  (unless otherwise stated)

| PARAMETER           | SYMBOL         | CONDITIONS  | MIN  | TYP    | MAX | UNITS    |
|---------------------|----------------|---|------|--------|-----|----------|
| Output Frequency    | $F_{O24M}$     |   |      | 24     |     | MHz      |
| Output Frequency    | $F_{O48M}$     |   |      | 48     |     | MHz      |
| Output Frequency    | $F_{OREF}$     |   |      | 14.318 |     | MHz      |
| Output Impedance    | $R_{DSP5}^1$   | $V_O = V_{DD}^*(0.5)$                             | 20   |        | 60  | $\Omega$ |
| Output Impedance    | $R_{DSN5}^1$   | $V_O = V_{DD}^*(0.5)$                             | 20   |        | 60  | $\Omega$ |
| Output High Voltage | $V_{OH5}$      | $I_{OH} = -16\text{ mA}$                          | 2.4  | 2.5    |     | V        |
| Output Low Voltage  | $V_{OL5}$      | $I_{OL} = 9\text{ mA}$                            |      | 0.2    | 0.4 | V        |
| Output High Current | $I_{OH5}$      | $V_{OH} = 2.0\text{ V}$                           |      | -29    | -22 | mA       |
| Output Low Current  | $I_{OL5}$      | $V_{OL} = 0.8\text{ V}$                           | 16   | 25     |     | mA       |
| Rise Time           | $t_{r5}^1$     | $V_{OL} = 0.4\text{ V}$ , $V_{OH} = 2.4\text{ V}$ |      | 1.8    | 4   | ns       |
| Fall Time           | $t_{f5}^1$     | $V_{OH} = 2.4\text{ V}$ , $V_{OL} = 0.4\text{ V}$ |      | 1.7    | 4   | ns       |
| Duty Cycle          | $d_{t5}^1$     | $V_T = 1.5\text{ V}$                              | 45   | 51     | 55  | %        |
| Jitter              | $t_{j1s5A}^1$  | $V_T = 1.5\text{ V}$ ; Fixed Clocks               |      | 50     | 150 | ps       |
|                     | $t_{j1s5B}^1$  | $V_T = 1.5\text{ V}$ ; Ref Clocks                 |      | 150    | 350 |          |
|                     | $t_{jabs5A}^1$ | $V_T = 1.5\text{ V}$ ; Fixed Clocks               | -250 | 120    | 250 |          |
|                     | $t_{jabs5B}^1$ | $V_T = 1.5\text{ V}$ ; Ref Clocks                 | -600 | -      | 600 | ps       |

<sup>1</sup>Guaranteed by design, not 100% tested in production.



## SSOP Package

| SYMBOL | COMMON DIMENSIONS |      |       | VARIATIONS | D    |      |      | N  |
|--------|-------------------|------|-------|------------|------|------|------|----|
|        | MIN.              | NOM. | MAX.  |            | MIN. | NOM. | MAX. |    |
| A      | .095              | .101 | .110  | AC         | .620 | .625 | .630 | 48 |
| A1     | .008              | .012 | .016  |            |      |      |      |    |
| A2     | .088              | .090 | .092  |            |      |      |      |    |
| B      | .008              | .010 | .0135 |            |      |      |      |    |
| C      | .005              | .006 | .0085 |            |      |      |      |    |
| D      | See Variations    |      |       |            |      |      |      |    |
| E      | .292              | .296 | .299  |            |      |      |      |    |
| e      | 0.025 BSC         |      |       |            |      |      |      |    |
| H      | .400              | .406 | .410  |            |      |      |      |    |
| h      | .010              | .013 | .016  |            |      |      |      |    |
| L      | .024              | .032 | .040  |            |      |      |      |    |
| N      | See Variations    |      |       |            |      |      |      |    |
| ∞      | 0°                | 5°   | 8°    |            |      |      |      |    |
| X      | .085              | .093 | .100  |            |      |      |      |    |

This table in inches

## Ordering Information

ICS9148yF-12LF-T

Example:

ICS XXXX y F PPP LF-T

Designation for tape and reel packaging

RoHS Compliant (Optional)

Pattern Number (2 or 3 digit number for parts with ROM code patterns)

Package Type

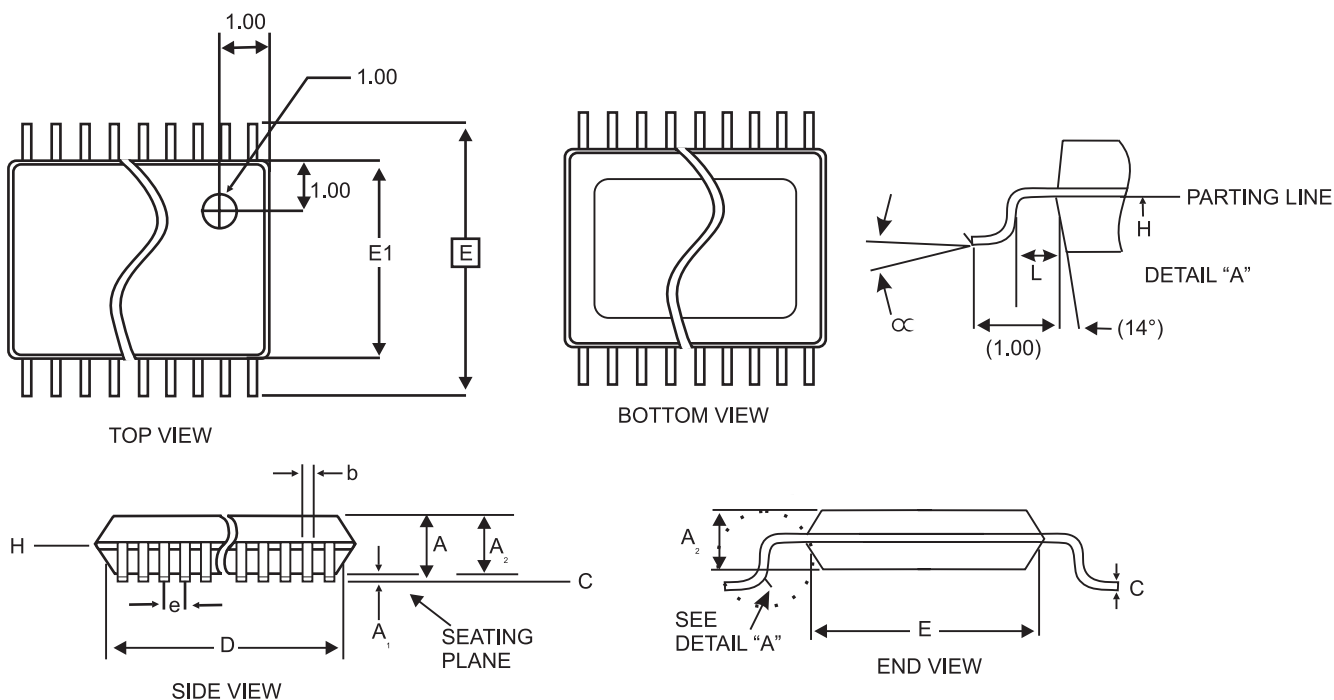
F = SSOP

Revision Designator (will not correlate with datasheet revision)

Device Type

Prefix

ICS = Standard Device



## 240 mil (6.10mm) TSSOP Package

| SYMBOL | COMMON DIMENSIONS |      |      | VARIATIONS |       |       | N  |
|--------|-------------------|------|------|------------|-------|-------|----|
|        |                   |      |      | D          |       |       |    |
|        | MIN.              | NOM. | MAX. | MIN.       | NOM.  | MAX.  |    |
| A      | —                 | —    | 1.10 | 12.40      | 12.50 | 12.60 | 48 |
| A1     | 0.05              | —    | 0.15 | 13.90      | 14.00 | 14.10 | 56 |
| A2     | 0.85              | 0.90 | 0.95 |            |       |       |    |
| b      | 0.17              | —    | 0.27 |            |       |       |    |
| C      | 0.09              | —    | 0.20 |            |       |       |    |
| D      | See Variations    |      |      |            |       |       |    |
| E1     | 6.00              | 6.10 | 6.20 |            |       |       |    |
| e      | 0.50 BSC          |      |      |            |       |       |    |
| E      | 8.10 BSC          |      |      |            |       |       |    |
| L      | 0.50              | 0.60 | 0.70 |            |       |       |    |
| N      | See Variations    |      |      |            |       |       |    |
| α      | 0°                | —    | 8°   |            |       |       |    |

## Ordering Information

### ICS9148yG-12LF-T

Example:

ICS XXXX y G PPP LF-T

Designation for tape and reel packaging

Lead Free (Optional)

Pattern Number (2 or 3 digit number for parts with ROM code patterns)

Package Type

G = TSSOP

Revision Designator (will not correlate with datasheet revision)

Device Type

Prefix

ICS = Standard Device

Dimensions are in millimeters

240TSSOP\_AN

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